## onsemi

### Quad 2-Input OR Gate

### **MM74HC32**

#### **General Description**

The MM74HC32 OR gates utilize advanced silicon–gate CMOS technology to achieve operating speeds similar to LS–TTL gates with the low power consumption of standard CMOS integrated circuits.

All gates have buffered outputs providing high noise immunity and the ability to drive 10 LS–TTL loads. The 74HC logic family is functionally as well as pin–out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to  $V_{CC}$  and ground.

#### Features

- Typical Propagation Delay: 10 ns
- Wide Power Supply Range: 2 V 6 V
- Low Quiescent Current: 20 µA maximum (74HC Series)
- Low Input Current: 1 µA Maximum
- Fanout of 10 LS–TTL Loads
- These Devices are Pb-Free, Halide Free and are RoHS Compliant

#### **Connection Diagram**

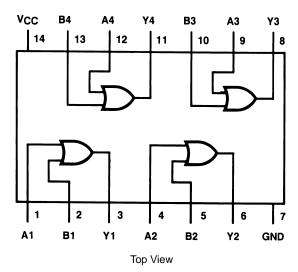


Figure 1. Pin Assignments for SOIC and TSSOP

Logic Diagram

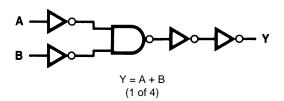
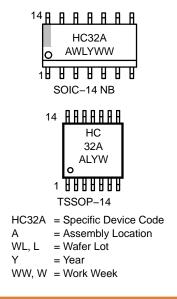


Figure 2. Logic Diagram



CASE 948G

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 4 of this data sheet.

#### ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol		Rating		
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0 V		
V <sub>IN</sub>	DC Input Voltage	DC Input Voltage		
V <sub>OUT</sub>	DC Output Voltage		-0.5 to V <sub>CC</sub> + 0.5 V	
I <sub>IK</sub> , I <sub>OK</sub>	Clamp Diode Current	Clamp Diode Current		
I <sub>OUT</sub>	DC Output Current, per Pin	±25 mA		
I <sub>CC</sub>	DC V <sub>CC</sub> or GND Current, per Pir	DC V <sub>CC</sub> or GND Current, per Pin		
T <sub>STG</sub>	Storage Temperature Range		–65°C to +150°C	
PD	Power Dissipation Note 2		600 mW	
		S.O. Package Only	500 mW	
ΤL	Lead Temperature (Soldering 10 Seconds)		260°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Unless otherwise specified all voltages are referenced to ground.

2. Power Dissipation temperature derating - plastic "N" package: -12 mW/°C from 65°C to 85°C.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter			Max	Unit
V <sub>CC</sub>	Supply Voltage			6	V
V <sub>IN</sub> , V <sub>OUT</sub>	DC Input or Output Voltage			V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature Range			+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Times	-	1000	ns	
	$V_{CC} = 4.5 V$		-	500	ns
		$V_{CC} = 6.0 V$	-	400	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### **MM74HC32**

#### DC CHARACTERISTICS (Note 3)

				T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	
Symbol	Parameter	V <sub>CC</sub> (V) Conditions	Тур Gu		aranteed Limits	Unit	
VIH	Minimum HIGH Level Input Voltage	2.0		-	1.5	1.5	V
		4.5		-	3.15	3.15	
		6.0		-	4.2	4.2	
VIL	Maximum LOW Level Input Voltage	2.0		-	0.5	0.5	V
		4.5		_	1.35	1.35	
		6.0		-	1.8	1.8	
V <sub>OH</sub>	Minimum HIGH Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.9	1.9	V
		4.5	I <sub>OUT</sub>   ≤ 20 μA	4.5	4.4	4.4	
		6.0		6.0	5.9	5.9	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT}  \le 4.0 \text{ mA}$	4.2	3.98	3.84	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT}  \le 5.2 \text{ mA}$	5.2	5.48	5.34	
V <sub>OL</sub>	Maximum LOW Level Output Voltage	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT}  \le 20 \ \mu A$	0	0.1	0.1	V
		4.5		0	0.1	0.1	
		6.0		0	0.1	0.1	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT}  \le 4.0 \text{ mA}$	0.2	0.26	0.33	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT}  \le 5.2 \text{ mA}$	0.2	0.26	0.33	
I <sub>IN</sub>	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND	-	±0.1	±1.0	μA
I <sub>CC</sub>	Maximum Quiescent Supply Current	6.0	$V_{IN} = V_{CC} \text{ or}$ GND, $I_{OUT} = 0 \ \mu A$	_	2.0	20	μA

3. For a power supply of 5 V  $\pm$ 10% the worst case output voltages (V<sub>OH</sub>, and V<sub>OL</sub>) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5 V and 4.5 V respectively. (The V<sub>IH</sub> value at 5.5 V is 3.85 V.) The worst case leakage current (I<sub>IN</sub>, I<sub>CC</sub>, and I<sub>OZ</sub>) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

#### AC CHARACTERISTICS (V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C, C<sub>L</sub> = 15 pF, $t_r$ = $t_f$ = 6 ns)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay		10	18	ns

#### AC CHARACTERISTICS (V<sub>CC</sub> = 2.0 V to 6.0 V, C<sub>L</sub> = 50 pF, $t_r = t_f = 6$ ns (unless otherwise specified))

				T <sub>A</sub> =	25°C	$T_A = -40^{\circ}C$ to $85^{\circ}C$	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Тур	Gua	ranteed Limits	Unit
t <sub>PHL</sub> , t <sub>PLH</sub>	Maximum Propagation Delay	2.0		30	100	125	ns
		4.5		12	20	25	
		6.0		9	17	21	
t <sub>TLH</sub> , t <sub>THL</sub>	Maximum Output Rise and Fall Time	2.0		30	75	95	ns
		4.5		8	15	19	
		6.0		7	13	16	
C <sub>PD</sub>	Power Dissipation Capacitance (Note 4)		(per gate)	50	-	-	pF
CIN	Maximum Input Capacitance			5	10	10	pF

4.  $C_{PD}$  determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

#### **MM74HC32**

#### **ORDERING INFORMATION**

Part Number	Package	Shipping <sup>†</sup>		
MM74HC32M	SOIC-14, Case 751A-03 (Pb-Free, Halide-Free)	55 Units / Tube		
MM74HC32MTC	TSSOP-14, Case 948G-01 (Pb-Free, Halide Free)	96 Units / Tube		
MM74HC32MX	SOIC-14, Case 751EF (Pb-Free, Halide-Free)	2500 Units / Tape & Reel		
MM74HC32MTCX	TSSOP–14, Case 948G–01 (Pb–Free, Halide Free)	2500 Units / Tape & Reel		

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

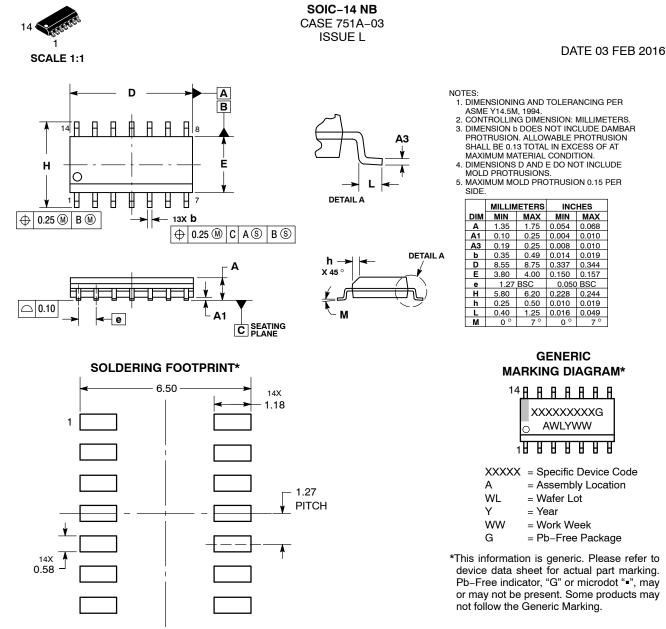
# DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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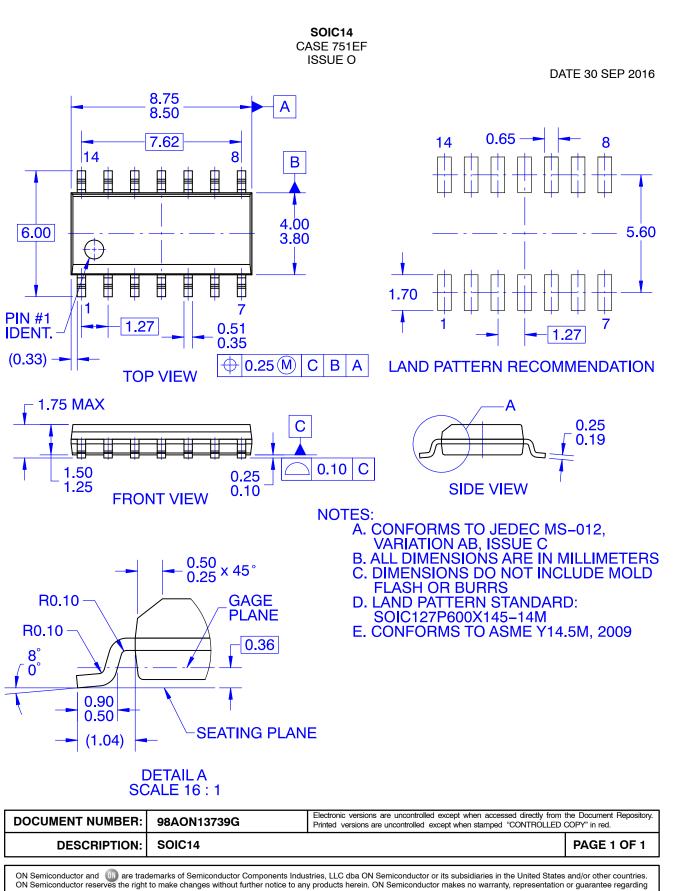
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STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5:	STYLE 6:	STYLE 7:	STYLE 8:
PIN 1. COMMON CATHODE	PIN 1. CATHODE	PIN 1. ANODE/CATHODE	PIN 1. COMMON CATHODE
2. ANODE/CATHODE	2. CATHODE	2. COMMON ANODE	2. ANODE/CATHODE
3. ANODE/CATHODE	3. CATHODE	3. COMMON CATHODE	3. ANODE/CATHODE
4. ANODE/CATHODE	4. CATHODE	4. ANODE/CATHODE	4. NO CONNECTION
5. ANODE/CATHODE	5. CATHODE	5. ANODE/CATHODE	5. ANODE/CATHODE
6. NO CONNECTION	6. CATHODE	6. ANODE/CATHODE	6. ANODE/CATHODE
7. COMMON ANODE	7. CATHODE	7. ANODE/CATHODE	7. COMMON ANODE
8. COMMON CATHODE	8. ANODE	8. ANODE/CATHODE	8. COMMON ANODE
9. ANODE/CATHODE	9. ANODE	10. ANODE/CATHODE	9. ANODE/CATHODE
10. ANODE/CATHODE	10. ANODE	11. COMMON CATHODE	10. ANODE/CATHODE
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12. ANODE/CATHODE	12. ANODE	13. ANODE/CATHODE	12. ANODE/CATHODE
13. NO CONNECTION	13. ANODE	14. ANODE/CATHODE	13. ANODE/CATHODE
14. COMMON ANODE	14. ANODE	14. ANODE/CATHODE	14. COMMON CATHODE

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